

October 2013

FQB22P10 — P-Channel QFET[®] MOSFET

FQB22P10

P-Channel QFET® MOSFET

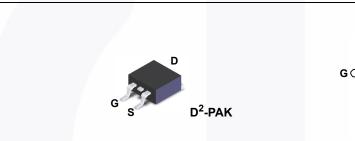
-100 V, -22 A, 125 m Ω

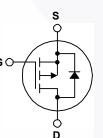
Description

This P-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- -22 A, -100 V, R_{DS(on)} = 125 m Ω (Max) @V_{GS} = -10 V, I_D = -11 A
- Low Gate Charge (Typ. 40 nC)
- Low Crss (Typ. 160 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating





Absolute Maximum Ratings T_c = 25°C unless otherwise noted

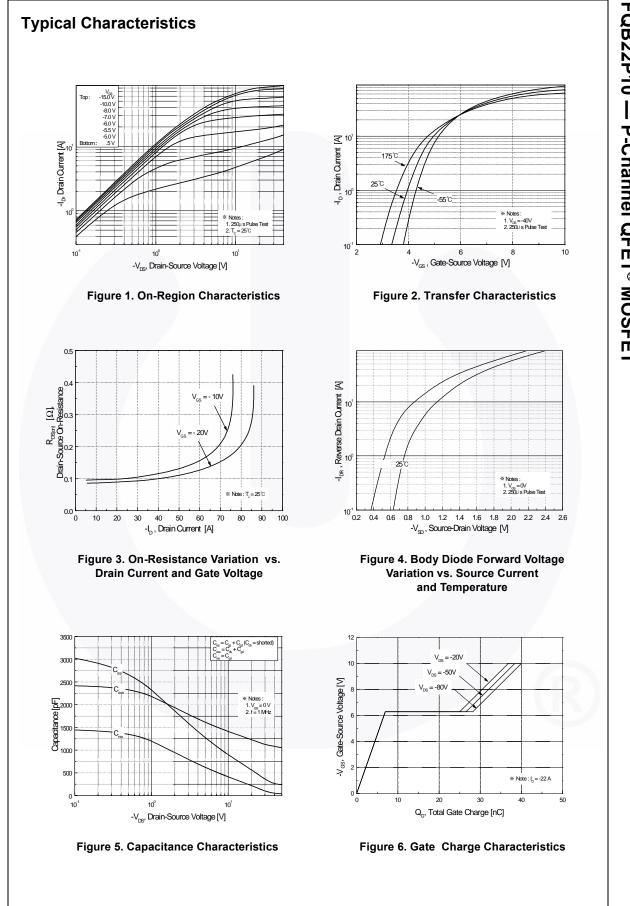
Symbol	Parameter		FQB22P10TM	Unit	
V _{DSS}	Drain-Source Voltage		-100	V	
I _D	Drain Current - Continuous (T _C = 25	-22	A		
	- Continuous (T _C = 10	-15.6	A		
I _{DM}	Drain Current - Pulsed	(Note 1)	-88	A	
V _{GSS}	Gate-Source Voltage		±30	V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	710	mJ A	
I _{AR}	Avalanche Current	(Note 1)	-22		
E _{AR}	Repetitive Avalanche Energy	(Note 1)	12.5	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-6.0	V/ns	
P _D	Power Dissipation $(T_A = 25^{\circ}C)^{*}$		3.75	W	
	Power Dissipation ($T_C = 25^{\circ}C$)		125	W	
	- Derate above 25°C		0.83	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C	
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	

Thermal Characteristics

Symbol	Parameter	FQB22P10TM	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	1.2		
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (minimum pad of 2 oz copper), Max.	62.5	°C/W	
	Thermal Resistance, Junction to Ambient (* 1 in ² pad of 2 oz copper), Max.	40		

Device N	larking	Device	Pack	Package Reel Size)	Tape V		Quantity	
FQB22P10		FQB22P10TM	D2-I	D2-PAK 330mm			24mm		800	
lectri	cal Cha	aracteristics	s = 25°C uni	ess otherwis	e noted					
Symbol		Parameter	, = 20 0 am		st Conditions		Min	Тур	Max	Unit
Off Cha	racteris	tics								
BV _{DSS}		urce Breakdown Voltage	V	$G_{GS} = 0 V,$	I _D = -250 μA		-100			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient			$I_D = -250 \ \mu$ A, Referenced to 25°C				-0.1		V/°C
IDSS	Zero Gate Voltage Drain Current		V	$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -80 \text{ V}, T_{C} = 125^{\circ}\text{C}$					-1	μA
			V						-10	μΑ
I _{GSSF}	Gate-Boo	Gate-Body Leakage Current, Forward		$V_{GS} = -30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$					-100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse		erse V	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$					100	nA
On Cha	racteris	tics								
V _{GS(th)}		eshold Voltage	V	V _{DS} = V _{GS} , I _D = -250 μA			-2.0		-4.0	V
R _{DS(on)}	Static Dra On-Resis	ain-Source stance		V _{GS} = -10 V, I _D = -11 A				0.096	0.125	Ω
9fs	Forward	Transconductance	V	_{DS} = -40	V, I _D = -11 A			13.5		S
Dynam	ic Chara	cteristics								
C _{iss}	Input Ca	pacitance	V	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz			1170	1500	pF	
C _{oss}	Output C	apacitance					460	600	pF	
C _{rss}	Reverse	Transfer Capacitance					160	200	pF	
Switchi	ng Char	acteristics								
t _{d(on)}	Turn-On	Delay Time	V	V _{DD} = -50 V, I _D = -22 A,			17	45	ns	
t _r	Turn-On	Rise Time		$L_{G} = 25 \Omega$				170	350	ns
t _{d(off)}	Turn-Off	Delay Time		G				60	130	ns
t _f	Turn-Off	Fall Time				(Note 4)		110	230	ns
Qg	Total Gat	e Charge	V	DS = -80	V, I _D = -22 A,			40	50	nC
Q _{gs}	Gate-Sou	urce Charge	V	_{GS} = -10	V			7.0		nC
Q _{gd}	Gate-Dra	in Charge				(Note 4)		21		nC
Drain-S	ource D	iode Characteristic	cs and	Maxim	um Rating					
I _S	1	n Continuous Drain-Sourc			•				-22	А
I _{SM}		n Pulsed Drain-Source Di							-88	A
V _{SD}		urce Diode Forward Volta			I _S = -22 A				-4.0	V
t _{rr}		Recovery Time	-		I _S = -22 A,			110		ns
Q _{rr}	Reverse	Recovery Charge	d	$I_F / dt = 1$	00 A/μs			0.6	-	μC
$\begin{array}{l} L=2.2mH,\ I\\ I_{SD}\leq \ -22A, \end{array}$	$AS = -22A, V_D$ di/dt $\leq 300A/$	width limited by maximum junction $_{D} = -25V$, $R_{G} = 25 \Omega$, Starting T_{J} μ s, $V_{DD} \leq BV_{DSS}$, Starting $T_{J} = 2$ operating temperature	= 25°C	e						

FQB22P10 — P-Channel QFET® MOSFET

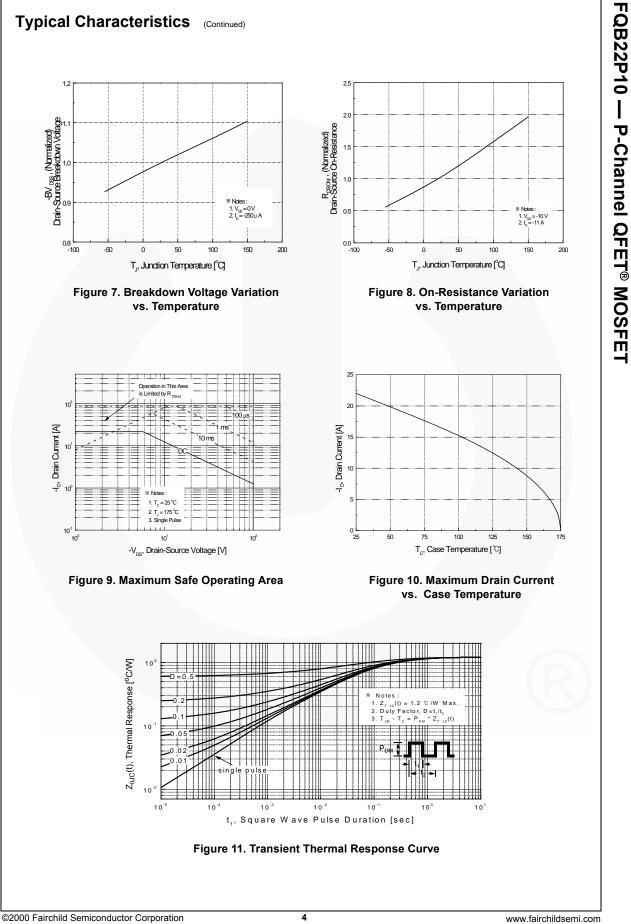


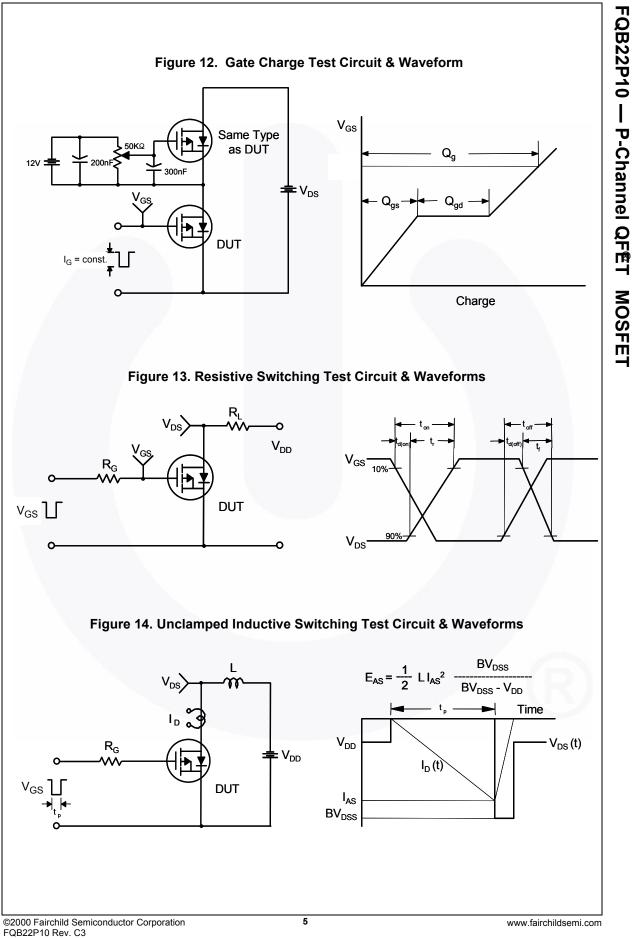
FQB22P10 — P-Channel QFET[®] MOSFET

www.fairchildsemi.com

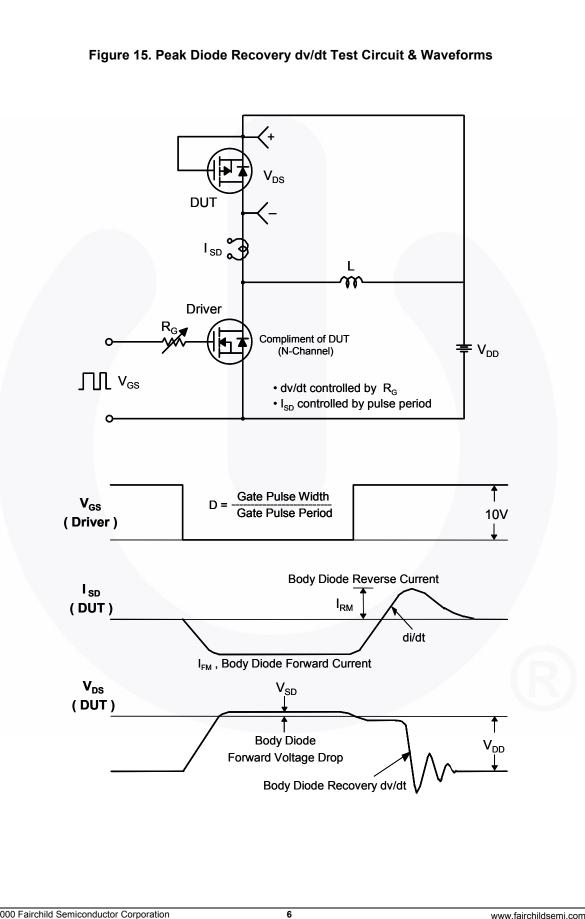
FQB22P10 Rev. C3

©2000 Fairchild Semiconductor Corporation

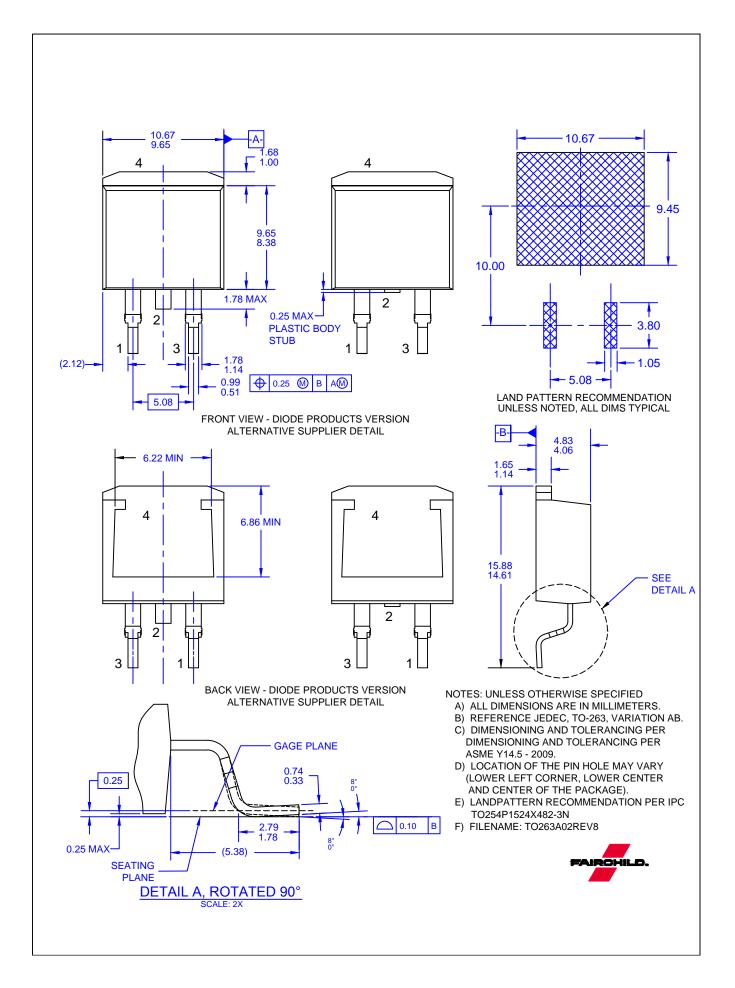




Downloaded from Arrow.com.



FQB22P10 — P-Channel QFET[®] MOSFET



ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81–3–5817–1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC

Downloaded from Arrow.com.